International Rectifier

AUTOMOTIVE GRADE

AUIRFBA1405

HEXFET® Power MOSFET

Features

- Advanced Planar Technology
- Low On-Resistance
- Dynamic dv/dt Rating
- 175°C Operating Temperature
- Fast Switching
- Fully Avalanche Rated
- Repetitive Avalanche Allowed up to Tjmax
- Lead-Free, RoHS Compliant
- Automotive Qualified*

G

V _{(BR)DSS}	55V		
R _{DS(on)} typ.	4.3 m $Ω$		
max	5.0m $Ω$		
I _D (Silicon Limited)	174A ®		
I _{D (Package Limited)}	95A		

Description

Specifically designed for Automotive applications, this Stripe Planar design of HEXFET® Power MOSFETs utilizes the latest processing techniques to achieve low on-resistance per silicon area. This benefit combined with the fast switching speed and ruggedized device design that HEXFET power MOSFETs are well known for, provides the designer with an extremely efficient and reliable device for use in Automotive and a wide variety of other applications.



G	D	S
Gate	Drain	Source

Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (T_A) is 25°C, unless otherwise specified.

	Parameter	Max.	Units
$I_D @ T_C = 25^{\circ}C$	Continuous Drain Current, V _{GS} @ 10V (Silicon Limited)	174®	
$I_D @ T_C = 100^{\circ}C$	Continuous Drain Current, VGS @ 10V (Silicon Limited)	123®	Α
I _D @ T _C = 25°C Continuous Drain Current, V _{GS} @ 10V (Package Limited)		95	
I _{DM}	Pulsed Drain Current ①	680	
P _D @T _C = 25°C	Power Dissipation	330	W
	Linear Derating Factor	2.2	W/°C
V_{GS}	Gate-to-Source Voltage	± 20	V
E _{AS}	Single Pulse Avalanche Energy (Thermally Limited) ②	560	mJ
I _{AR}	Avalanche Current ①	See Fig.12a, 12b, 15, 16	Α
E _{AR}	Repetitive Avalanche Energy ⑦		mJ
dv/dt	Peak Diode recovery dv/dt ③	5.0	V/ns
T_J	Operating Junction and	-40 to + 175	
T _{STG}	Storage Temperature Range	-55 to + 175	°C
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)	

Thermal Resistance

	Parameter	Тур.	Max.	Units
$R_{\theta JC}$	Junction-to-Case ®		0.45	
$R_{\theta}cs$	Case-to-Sink, Flat, Greased Surface	0.50		°C/W
$R_{\theta JA}$	Junction-to-Ambient		58	

HEXFET® is a registered trademark of International Rectifier.

^{*}Qualification standards can be found at http://www.irf.com/

AUIRFBA1405

Static Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	55			V	$V_{GS} = 0V, I_D = 250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_{c}$	Breakdown Voltage Temp. Coefficient		0.057		V/°C	Reference to 25°C, I _D = 1mA
R _{DS(on)}	Static Drain-to-Source On-Resistance		4.3	5.0	mΩ	V _{GS} = 10V, I _D = 101A ④
V _{GS(th)}	Gate Threshold Voltage	2.0		4.0	V	$V_{DS} = 10V, I_{D} = 250\mu A$
gfs	Forward Transconductance	69			S	$V_{DS} = 25V, I_{D} = 110A$
I _{DSS}	Drain-to-Source Leakage Current			20	μΑ	$V_{DS} = 55V, V_{GS} = 0V$
				250		$V_{DS} = 44V, V_{GS} = 0V, T_{J} = 150^{\circ}C$
I _{GSS}	Gate-to-Source Forward Leakage			200	nA	$V_{GS} = 20V$
	Gate-to-Source Reverse Leakage			-200		$V_{GS} = -20V$

Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
Qg	Total Gate Charge		170	260		I _D = 101A
Q_{gs}	Gate-to-Source Charge		44	66	nC	$V_{DS} = 44V$
Q_{gd}	Gate-to-Drain ("Miller") Charge		62	93		V _{GS} = 10V ④
t _{d(on)}	Turn-On Delay Time		13			$V_{DD} = 38V$
t _r	Rise Time		190			I _D = 110A
t _{d(off)}	Turn-Off Delay Time		130		ns	$R_G = 1.1 \Omega$
t _f	Fall Time		110			V _{GS} = 10V ④
L_D	Internal Drain Inductance		4.5			Between lead,
			4.5		nΗ	6mm (0.25in.)
Ls	Internal Source Inductance		7.5			from package
			7.5			and center of die contact
Ciss	Input Capacitance		5480			$V_{GS} = 0V$
Coss	Output Capacitance		1210			$V_{DS} = 25V$
Crss	Reverse Transfer Capacitance		280		pF	f = 1.0MHz, See Fig.5
Coss	Output Capacitance		5210			$V_{GS} = 0V$, $V_{DS} = 1.0V$, $f = 1.0MHz$
Coss	Output Capacitance		900			$V_{GS} = 0V$, $V_{DS} = 44V$, $f = 1.0MHz$
Coss eff.	Effective Output Capacitance ©		1500			$V_{GS} = 0V$, $V_{DS} = 0V$ to 44V

Diode Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions
Is	Continuous Source Current (Body Diode)			174©	А	MOSFET symbol showing the
I _{SM}	Pulsed Source Current (Body Diode) ①			680		integral reverse p-n junction diode.
V_{SD}	Diode Forward Voltage			1.3	V	$T_J = 25^{\circ}C$, $I_S = 101A$, $V_{GS} = 0V$ ④
t _{rr}	Reverse Recovery Time		88	130	ns	$T_J = 25^{\circ}C$, $I_F = 101A$
Qr	Reverse Recovery Charge		250	380	nC	di/dt = 100A/µs ④
ton	Forward Turn-On Time	Intrins	c turn-o	n time is	s negligi	ble (turn-on is dominated by LS+LD)

Notes:

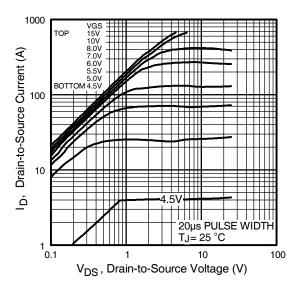
- ① Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11).
- $$\label{eq:starting} \begin{split} \text{ } &\mathbb{O} \text{ Starting } T_J = 25^{\circ}\text{C}, \ L = 0.11\text{mH} \\ &\mathbb{O} \text{R}_G = 25\Omega, \ I_{AS} = 101\text{A}. \ \text{(See Figure 12)}. \end{split}$$
- ③ $I_{SD} \le 101A$, $di/dt \le 210A/\mu s$, $V_{DD} \le V_{(BR)DSS}$, $T_J \le 175^{\circ}C$.
- 4 Pulse width \leq 400 μ s; duty cycle \leq 2%.
- $^{\circ}$ C_{oss} eff. is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS} . Refer to AN-1001.
- © Calculated continuous current based on maximum allowable junction temperature. Package limitation current is 95A.
- $\ \ \,$ Limited by T_{Jmax} , see Fig.12a, 12b, 15, 16 for typical repetitive avalanche performance.
- $\ ^{\textcircled{\$}}$ $\ ^{\textbf{R}}\theta$ is measured at T_{J} of approximately 90°C.

Qualification Information[†]

		Automotive				
		(per AEC-Q101)				
Qualification	Level	Comments: This part number(s) passed Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.				
Moisture Sens	sitivity Level	TO-220	N/A			
	Machine Model		Class M4 (+/- 600V) ††			
		AEC-Q101-002				
ECD	Human Body Model		Class H2 (+/- 4000V) ††			
ESD			AEC-Q101-001			
	Charged Device Model	Class C5 (+/- >2000V) ††				
		AEC-Q101-005				
RoHS Compliant Yes			Yes			

[†] Qualification standards can be found at International Rectifier's web site: http://www.irf.com/

^{††} Highest passing voltage.



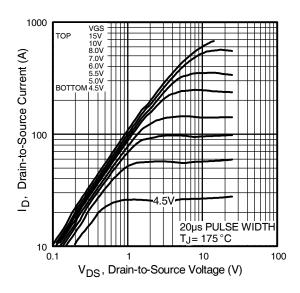
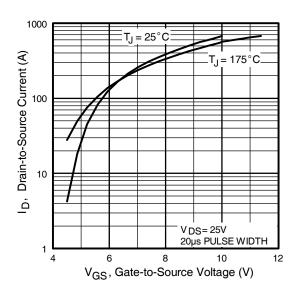


Fig 1. Typical Output Characteristics

Fig 2. Typical Output Characteristics



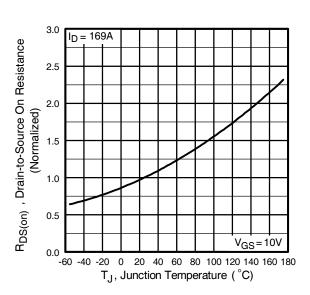
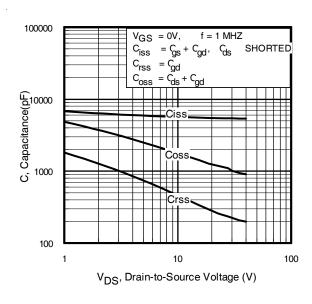


Fig 3. Typical Transfer Characteristics

Fig 4. Normalized On-Resistance Vs. Temperature



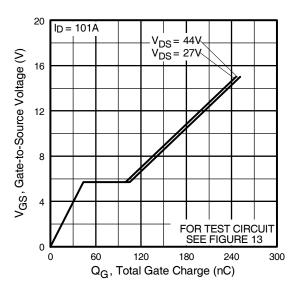
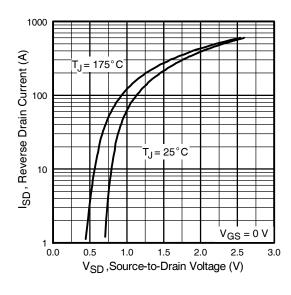


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage



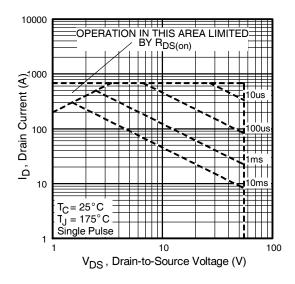


Fig 7. Typical Source-Drain Diode Forward Voltage

Fig 8. Maximum Safe Operating Area

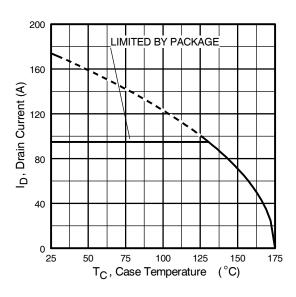


Fig 9. Maximum Drain Current Vs. Case Temperature

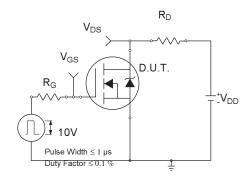


Fig 10a. Switching Time Test Circuit

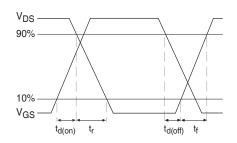


Fig 10b. Switching Time Waveforms

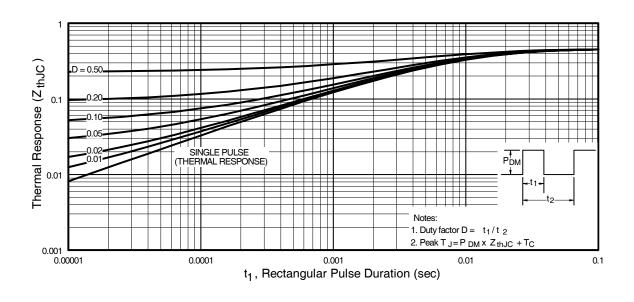


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

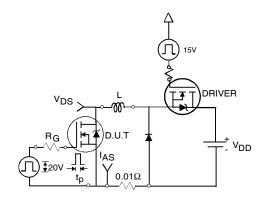


Fig 12a. Unclamped Inductive Test Circuit

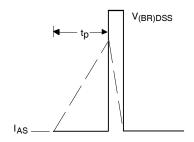


Fig 12b. Unclamped Inductive Waveforms

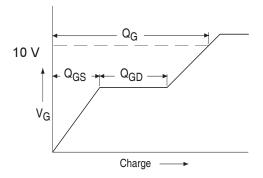
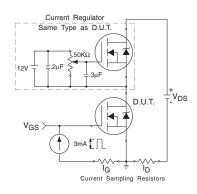


Fig 13a. Basic Gate Charge Waveform



Parting T_J, Junction Temperature (°C)

Fig 12c. Maximum Avalanche Energy Vs. Drain Current

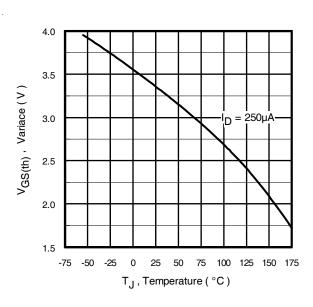


Fig 14. Threshold Voltage Vs. Temperature

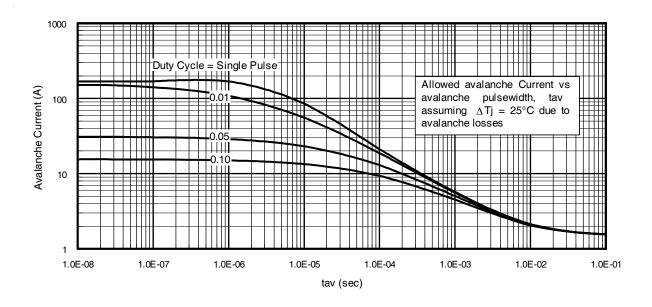


Fig 15. Typical Avalanche Current Vs. Pulsewidth

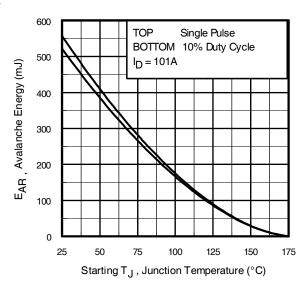


Fig 16. Maximum Avalanche Energy Vs. Temperature

Notes on Repetitive Avalanche Curves, Figures 15, 16: (For further info, see AN-1005 at www.irf.com)

- Avalanche failures assumption:
- Purely a thermal phenomenon and failure occurs at a temperature far in excess of T_{jmax} . This is validated for every part type.
- 2. Safe operation in Avalanche is allowed as long asT_{jmax} is not exceeded.
- 3. Equation below based on circuit and waveforms shown in Figures 12a, 12b.
- P_{D (ave)} = Average power dissipation per single avalanche pulse.
- BV = Rated breakdown voltage (1.3 factor accounts for voltage increase during avalanche).
- 6. I_{av} = Allowable avalanche current.
- 7. ΔT = Allowable rise in junction temperature, not to exceed T_{jmax} (assumed as 25°C in Figure 15, 16).

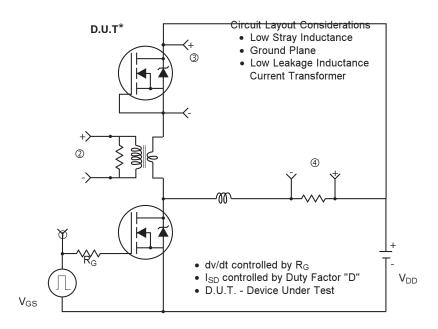
 t_{av} = Average time in avalanche.

D = Duty cycle in avalanche = $t_{av} \cdot f$

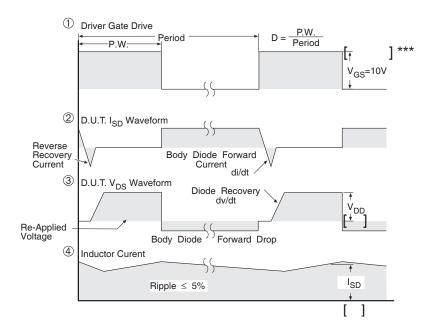
 $Z_{th,JC}(D, t_{av})$ = Transient thermal resistance, see figure 11)

$$\begin{split} P_{D \text{ (ave)}} &= 1/2 \text{ (} 1.3 \cdot \text{BV} \cdot I_{av} \text{)} = \triangle \text{T} / Z_{thJC} \\ I_{av} &= 2\triangle \text{T} / \left[1.3 \cdot \text{BV} \cdot Z_{th} \right] \\ E_{AS \text{ (AR)}} &= P_{D \text{ (ave)}} \cdot t_{av} \end{split}$$

Peak Diode Recovery dv/dt Test Circuit



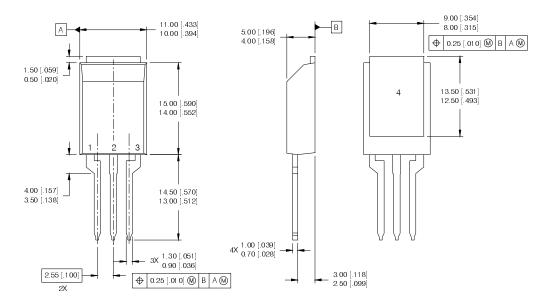
^{*} Reverse Polarity of D.U.T for P-Channel



^{***} V_{GS} = 5.0V for Logic Level and 3V Drive Devices

Fig 17. For N-channel HEXFET® power MOSFETs

Super-220™ Package Outline



NOTES:

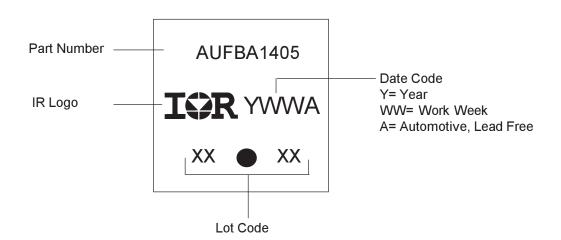
- 1. DIMENSIONING & TOLERANCING PER ASME Y14.5M-1994.
- 2. CONTROLLING DIMENSION: MILLIMETER.
- 3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
- 4. OUTLINE CONFORMS TO JEDEC OUTLINE TO-273AA.

LEAD ASSIGNMENTS

MOSFET	<u>IGBT</u>
1 - GATE	1 - GATE
2 - DRAIN	2 - COLLECTOR
3 - SOURCE	3 - EMITTER
4 - DRAIN	4 - COLLECTOR

Super-220™ not recommended for surface mount application

Super-220 Part Marking Information



Note: For the most current drawing please refer to IR website at http://www.irf.com/package/

Ordering Information

Base part number	Package Type	Standard Pack		Complete Part Number
		Form	Quantity	
AUIRFBA1405	Super-220	Tube	50	AUIRFBA1405

IMPORTANT NOTICE

Unless specifically designated for the automotive market, International Rectifier Corporation and its subsidiaries (IR) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or services without notice. Part numbers designated with the "AU" prefix follow automotive industry and / or customer specific requirements with regards to product discontinuance and process change notification. All products are sold subject to IR's terms and conditions of sale supplied at the time of order acknowledgment.

IR warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with IR's standard warranty. Testing and other quality control techniques are used to the extent IR deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

IR assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using IR components. To minimize the risks with customer products and applications, customers should provide adequate design and operating safeguards.

Reproduction of IR information in IR data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alterations is an unfair and deceptive business practice. IR is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of IR products or serviced with statements different from or beyond the parameters stated by IR for that product or service voids all express and any implied warranties for the associated IR product or service and is an unfair and deceptive business practice. IR is not responsible or liable for any such statements.

IR products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or in other applications intended to support or sustain life, or in any other application in which the failure of the IR product could create a situation where personal injury or death may occur. Should Buyer purchase or use IR products for any such unintended or unauthorized application, Buyer shall indemnify and hold International Rectifier and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that IR was negligent regarding the design or manufacture of the product.

Only products certified as military grade by the Defense Logistics Agency (DLA) of the US Department of Defense, are designed and manufactured to meet DLA military specifications required by certain military, aerospace or other applications. Buyers acknowledge and agree that any use of IR products not certified by DLA as military-grade, in applications requiring military grade products, is solely at the Buyer's own risk and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

IR products are neither designed nor intended for use in automotive applications or environments unless the specific IR products are designated by IR as compliant with ISO/TS 16949 requirements and bear a part number including the designation "AU". Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, IR will not be responsible for any failure to meet such requirements.

For technical support, please contact IR's Technical Assistance Center http://www.irf.com/technical-info/

WORLD HEADQUARTERS:

101 N. Sepulveda Blvd., El Segundo, California 90245 Tel: (310) 252-7105

AMEYA360 Components Supply Platform

Authorized Distribution Brand:

























Website:

Welcome to visit www.ameya360.com

Contact Us:

> Address:

401 Building No.5, JiuGe Business Center, Lane 2301, Yishan Rd Minhang District, Shanghai , China

> Sales:

Direct +86 (21) 6401-6692

Email amall@ameya360.com

QQ 800077892

Skype ameyasales1 ameyasales2

Customer Service :

Email service@ameya360.com

Partnership :

Tel +86 (21) 64016692-8333

Email mkt@ameya360.com